

## Application Data Sheet

### Application Information

Application Type:: Regular  
Subject Matter:: Utility  
Suggested Group Art Unit:: Not Yet Assigned  
CD-ROM or CD-R?:: None  
Sequence submission?:: None  
Computer Readable Form (CRF)?:: No  
Title:: **ADJUSTING DIE PLACEMENT ON A SEMICONDUCTOR WAFER TO INCREASE YIELD**  
  
Attorney Docket Number:: 524322000600  
Request for Early Publication?:: No  
Request for Non-Publication?:: Yes  
Total Drawing Sheets:: 6 (Formal)  
Small Entity?:: Yes  
Petition included?:: No  
Secrecy Order in Parent Appl.?:: No

### Applicant Information

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Israel  
Status:: Full Capacity  
Given Name:: Eitan  
Middle Name::  
Family Name:: CADOURI  
City of Residence:: Cupertino  
State or Province of Residence:: California  
Country of Residence:: United States of America  
Street of mailing address:: 937 Liberty Court  
City of mailing address:: Cupertino

State or Province of mailing address:: California  
Postal or Zip Code of mailing address:: 95014

### **Correspondence Information**

Correspondence Customer Number:: 20872

### **Representative Information**

Representative Customer Number:: 20872

### **Domestic Priority Information**

Application::	Continuity Type:	Parent Application::	Parent Filing Date::
This application	<i>An application claiming the benefit under 35 USC 119(e)</i>	60/454,706	03/17/03

### **Foreign Priority Information**

Country::	Application Number::	Filing Date::	Priority Claimed::
N/A			

### **Assignee Information**

Assignee name:: PDF Solutions, Inc.  
Street of Mailing Address:: 333 West San Carlos, Suite 700  
City of Mailing Address:: San Jose  
State or Province of Mailing Address:: California  
Postal or Zip Code of Mailing Address:: 95110